

# PRODUCT RELIABILITY REPORT FOR

**DS1023, Rev B2** 

**Dallas Semiconductor** 

4401 South Beltwood Parkway Dallas, TX 75244-3292

Prepared by:

Ken Wendel

Ken Wendel Reliability Engineering Manager Dallas Semiconductor 4401 South Beltwood Pkwy. Dallas, TX 75244-3292 Email: ken.wendel@dalsemi.com

ph: 972-371-3726 fax: 972-371-6016 mbl: 214-435-6610

#### Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

### **Device Description:**

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l\_datasheet3.cfm.

## **Reliability Derating:**

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
```

Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
```

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 23921 FITS: 4.8

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volts

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data.

#### **Device Information:**

Process: 1P, 1M, 0.8um, EPROM, Nd & Pd DSD , WJ BPSG

Passivation: Passivation w/Nov TEOS Oxide-OxyNitride

Die Size: 129 x 101

Number of Transistors: 0

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 175 Å

ELECTRICAL CHARACTER	RIZATION
----------------------	----------

DESCRIPTION	DATE CODE CONDITION		REA	OPOINT	QTY	FAILS	FA#
ESD SENSITIVITY	0115	EOS/ESD S5.1 HBM 500 VOLTS	2	PUL'S	3	0	
ESD SENSITIVITY	0115	EOS/ESD S5.1 HBM 1000 VOLTS	2	PUL'S	3	0	
ESD SENSITIVITY	0115	EOS/ESD S5.1 HBM 2000 VOLTS	2	PUL'S	3	0	
ESD SENSITIVITY	0115	EOS/ESD S5.1 HBM 4000 VOLTS	2	PUL'S	3	0	
ESD SENSITIVITY	0115	EOS/ESD S5.1 HBM 8000 VOLTS	2	PUL'S	3	3	No FA
LATCH-UP	0115	JESD78, I-TEST 70C	2	DYS	3	0	
LATCH-UP	0115	JESD78, Vsupply TEST 70C	2	DYS	3	0	
				Total:		3	

OPERATING LIFE							
DESCRIPTION	DATE CODE CONDITION		REAL	READPOINT		FAILS	FA#
INFANT LIFE	9802	125C, 7.0 VOLTS	48	HRS	256	0	
INFANT LIFE	0007	125C, 7.0 VOLTS	48	HRS	256	0	
HIGH VOLTAGE LIFE	0007	125C, 7.0 VOLTS	1000	HRS	179	0	

0

Total:

FAILURE RATE: MTTF (YRS): 23921 FITS: 4.8